Nano-engineered ultra-high-gain microchannel plates

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1. Introduction

Compact and efficient microchannel plate (MCP) electron multipliers are widely used in a variety of applications ranging from astrophysical sensors to mass spectroscopy, synchrotron instrumentation, image intensifiers, and many others. Recent advances in MCP readouts and their associated electronics allow two-dimensional imaging of photon/electron/ion/neutral particles with better than <10μm positional [1] and <20ps timing resolution [2] and with very low background rates of less than 0.01 counts/cm²/s. At the same time, developments in photocathode technology have substantially improved and extended the range of sensitivity [3]. However, the state of the art of MCP manufacturing has not advanced significantly since the mid-1970s. The parameters of electron amplification in an MCP device have still relatively large variation from one production run to another. This is the result of difficulty in controlling glass composition and manufacturing processes.

Improved sensitivity, resolution, and increased lifetime in image intensifier applications; higher detection efficiency, better time and spatial resolution in scientific instrumentation; emerging fluorescence imaging applications in biotechnology; all demand advances in MCP technology. Although several attempts have been made to produce MCPs with state-of-the-art processing, such as silicon micromachining [4–7] and lithographic etching/punching of anodic alumina [8–10], none of those technologies have matured enough to produce viable MCPs.

At the same time, the great progress that has been achieved in thin-film engineering makes available many deposition and nanotechnologies that can now be used to bring performance and manufacturing improvements to the MCP device. In this paper we demonstrate how these new technologies can be used to improve the performance of existing lead glass MCPs by improving their gain and lifetime. In addition, the same thin-film technologies enable MCP production from a wide range of substrate materials, separating the MCP manufacturing from lead glass technology. The conduction and secondary electron emission layers of novel MCPs do not have to be determined by the substrate material and can be individually tuned for a particular application. A wide range of substrates can now be used in MCP manufacturing, thereby improving many device parameters. The accuracy of lithographic etching can improve the spatial uniformity of MCP devices, the bulk conductive substrates may reduce the ion feedback problems [11], high-temperature compatibility may extend the range of opaque photocathodes, and the absence of radioactive elements in the substrate will further improve the dark count rate characteristics of MCP devices.

2. Experimental results

2.1. Improvements of existing glass MCPs

Gain, lifetime, and uniformity are the crucial parameters determining the ultimate performance of an MCP device.
Although the processes of MCP ageing are not yet completely understood on the microscopic level [12], it is well known that the secondary electron emission properties of pore walls degrade with the extracted charge [13]. To stabilize the detector operation a time-consuming process of electron scrubbing is performed before the MCP devices are delivered. Moreover, gain degradation limits the overall lifetime of the device since gain compensation, by increasing the operating voltage, has its limits.

Modification of the emission properties of the existing glass MCPs was the first step towards fully nano-engineered conduction and emission films. A set of commercially available MCPs was used. Fig. 1 shows the gain of those MCPs measured before and after the treatment. The gain of treated MCPs was routinely measured to increase by a factor of 5–10 for a variety of MCP geometries and initial gains. The gain saturation at high input currents did not change after treatment, as expected, and was measured to onset at usual ~10% of the strip current. Indeed, the current saturation is determined by the ability of pores to recharge and is mostly governed by the resistance of the pore conduction layer, which we did not modify in these devices. The tunneling of charges into the emission layer was still the limiting factor for count rate capabilities of the MCP treated with the emission layer. The uniformity of the treated MCPs was also found to remain unchanged; Fig. 2 confirms the good spatial uniformity of the new treatment.

The gain degradation of the treated MCP was found to be substantially reduced, as shown in Fig. 3. The gain reached stable operation after 0.02 C/cm² was extracted at a typical output current equal to 10–20% of the strip current, while a similar pre-treated plate required 0.1 C/cm² charge extraction.

The same treatment of commercially available MCPs can be used to revive the aged MCPs and increase their gain to levels higher than their measured un-aged values. Fig. 4 shows the gain of two initially identical commercial MCPs measured as a function of the extracted charge. One of them (MCP2) was treated immediately after it was received from the manufacturer, while the other was treated after it was scrubbed with ~0.025 C/cm² (MCP1). As seen in Fig. 4, the gain of aged MCP increased by a factor of ~8. After that the ageing curves of two MCPs appeared to be very similar with further scrubbing. The latter fact may suggest that ageing in lead glass commercial MCPs may be determined by the variation in the interface of resistive/emissive films, rather than solely by the degradation of secondary electron emission properties of the emissive layer.

2.2. MCPs with nano-engineered conduction and emission layers

The conduction and emission properties of pore walls in the existing commercial MCPs are determined by the composition of the lead glass. Hydrogen firing is used for the reduction of lead glass in order to achieve a desired conductivity, optimized between two conflicting requirements of efficient charge replenishment and low Joule heat generation. The emission properties are also predetermined by the substrate composition as the thin emission layer (silicon oxide), in turn, is formed from the conduction film during this same reduction process. The natural extension of the work reported in the previous section was to build both conduction and emission layers by the newly designed deposition techniques. Since these films are very different in...
composition, thickness, and functionality it is possible, in contrast to the lead glass process, to independently optimize the performance of each film.

Preliminary attempts used unfired substrates (some of which were lead free) that had both conductive and emissive films consecutively deposited. The resulting properties of these novel MCPs do not depend on the substrate type on which they are deposited as long as the adhesion to the substrate is sufficient. Figs. 5a and 6a show the measured resistance of the nano-engineered MCPs with two different types of geometry: ~5 and ~10 μm pore diameters. The resistivity of the conduction film was intentionally tuned in order to produce MCPs with target resistances of a few hundred MΩ. The resistance was found to be stable at accelerating biases up to 1 kV and the thermal coefficient of resistance was comparable to standard values observed with standard lead glass MCPs. The same graphs show the measured gains under electron bombardment. The gain reached very high values of 40,000 for a single-stage 40:1 \( L/D \) device biased at 1000 V. The gain saturation was observed to appear at output currents equal to ~10–30% of strip currents, as seen in Figs. 5b and 6b.

3. Conclusion

Novel nano-engineered films were shown to be successfully and uniformly deposited onto MCPs. MCP treatment with high
secondary electron emission film leads to a substantial, 5–10 ×, gain increase over commercial lead glass MCPs. These devices exhibited extended lifetime and required a reduced scrubbing dose for preconditioning to stabilize gain. Moreover, the same treatment can be used to revive aged MCPs. Very high gains measured with a single-stage device may eliminate the need for a multiple-stacking configuration that is necessary in order to achieve an acceptable amplification factor. The demonstrated deposition of both conduction and emission films on a non-lead glass substrate enables the separation of electrical properties of the resulting MCP from the substrate material, enabling MCP production from a wide range of substrate materials and geometries, including micromachined structures and bulk conductive and/or high-temperature-compatible substrates.

References